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#### April 2015

## FDB082N15A N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 117 A, 8.2 mΩ

#### Features

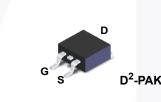
- $R_{DS(on)}$  = 6.7 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 75 A
- · Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 64.5 nC (Typ.)
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

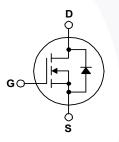
#### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





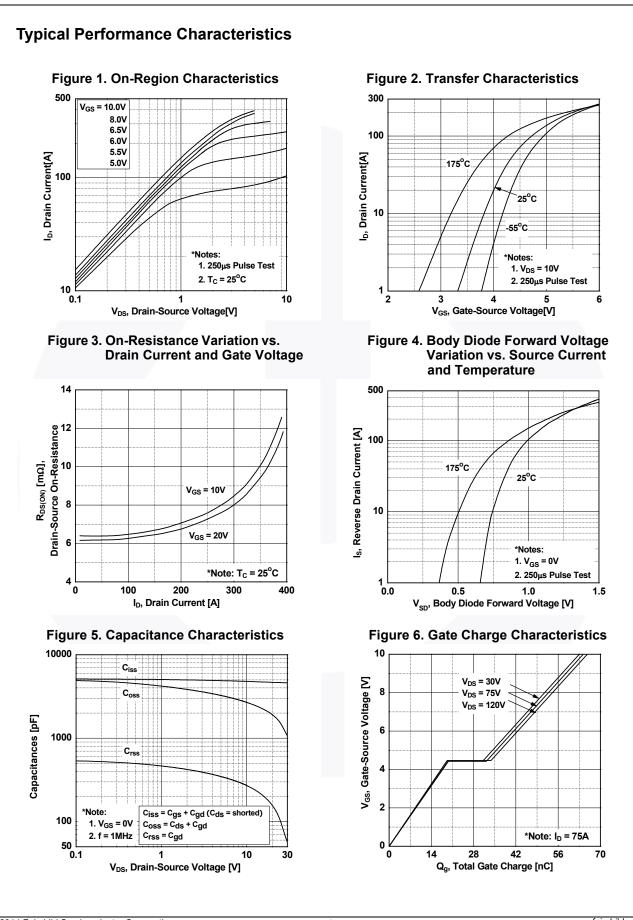
#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

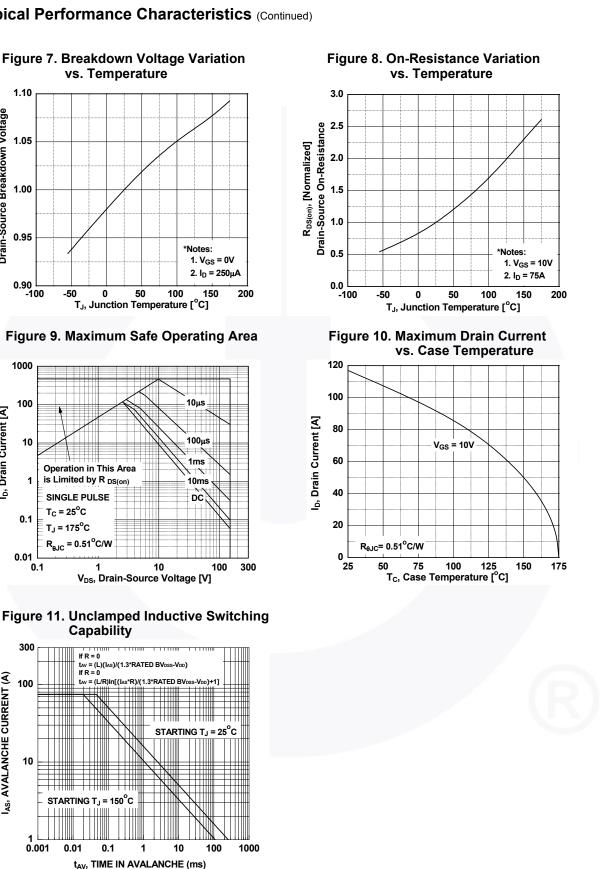
| Symbol                            |                                | FDB082N15A   | Unit<br>V |      |  |
|-----------------------------------|--------------------------------|--|-----------|------|--|
| V <sub>DSS</sub>                  | Drain to Source Voltage        | 150  |           |      |  |
| V <sub>GSS</sub>                  | Cata ta Sauraa Maltaga         | - DC   | ±20       | V    |  |
|                                   | Gate to Source Voltage         | - AC (f > 1 Hz)  | ±30       | V    |  |
| I <sub>D</sub>                    | Drain Current                  | - Continuous (T <sub>C</sub> = 25°C, Silicon Limited)  | 117       | A    |  |
|                                   | Drain Current                  | - Continuous (T <sub>C</sub> = 100°C, Silicon Limited) | 83        |      |  |
| I <sub>DM</sub>                   | Drain Current                  | - Pulsed (Note 1)                                      | 468       | Α    |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy | 542  | mJ        |      |  |
| dv/dt                             | Peak Diode Recovery dv/dt      | (Note 3)   | 6         | V/ns |  |
| P <sub>D</sub>                    | Dower Dissinction              | (T <sub>C</sub> = 25°C)                                | 294       | W    |  |
|                                   | Power Dissipation              | - Derate Sbove 25°C                                    | 1.96      | W/ºC |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Tempera  | -55 to +175  | °C        |      |  |
| TL                                | Maximum Lead Temperature for   | 300  | °C        |      |  |

#### **Thermal Characteristics**

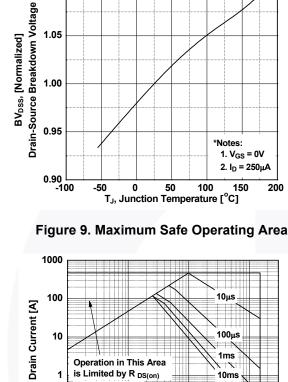
| Symbol          | Parameter                                     | FDB082N15A | Unit |  |  |
|-----------------|---|------------|------|--|--|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.51       | °C/W |  |  |
| $R_{\thetaJA}$  | Thermal Resistance, Junction to Ambient, Max. | 62.5       | °C/W |  |  |

|                                    | nber   | Top Mark                      | Packag              | e Packing Meth   | od Reel Siz | e Tap | be Width | Qua       | ntity    |
|------------------------------------|--|-------------------------------|---------------------|--|-------------|-------|----------|-----------|----------|
| FDB082N                            | FDB082N15A FDB082N15A D  |                               | D <sup>2</sup> -PAK | Tape and Re  | el 330 mn   | า 2   | 24 mm    | 800 units |          |
| Electrica                          | l Chara  | acteristics T <sub>C</sub> =2 | 5ºC unless          | otherwise noted.   |             |       |          |           |          |
| Symbol                             |  | Parameter                     |                     | Test Cor   | nditions    | Min.  | Тур.     | Max.      | Uni      |
| Off Charac                         | toristics  |                               |                     |  |             |       | 4        | r.        |          |
| BV <sub>DSS</sub>                  |  |                               | tana                | I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>C</sub> = 25 <sup>o</sup> C     |             |       | _        | -         | V        |
| ∆BV <sub>DSS</sub>                 | Drain to Source Breakdown Voltage<br>Breakdown Voltage Temperature   |                               | -                   |  |             |       | -        | -         |          |
| $/\Delta T_J$                      | Coefficient  |                               | C                   | $I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C                                      |             |       | 0.08     | -         | V/ºC     |
|                                    | Zero Gate Voltage Drain Current  |                               | .+                  | $V_{DS}$ = 120 V, $V_{GS}$ = 0 V<br>$V_{DS}$ = 120 V, $T_{C}$ = 150°C                  |             |       | -        | 1         |          |
| DSS                                |  |                               | IL .                |  |             |       | -        | 500       | μΑ       |
| I <sub>GSS</sub>                   | Gate to Body Leakage Current   |                               |                     | $V_{GS} = \pm 20 V, V_{DS} = 0 V$  |             |       | -        | ±100      | nA       |
| On Charac                          | teristics  |                               |                     |  |             |       |          |           |          |
| V <sub>GS(th)</sub>                | Gate Thr   | reshold Voltage               |                     | $V_{GS} = V_{DS}, I_{D} = 25$  | 50 μA       | 2.0   | -        | 4.0       | V        |
| R <sub>DS(on)</sub>                |  | ain to Source On Resis        | tance               | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7$   |             | -     | 6.7      | 8.20      | mΩ       |
| 9FS                                | Forward Transconductance   |                               |                     | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 75$  |             | -     | 139      | -         | S        |
|                                    |  |                               |                     | 50 5   |             |       | _        |           |          |
| Dynamic C                          |  |                               |                     | 1  |             |       | 1        |           |          |
| C <sub>iss</sub>                   |  | pacitance                     |                     | V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,   |             | -     | 4645     | 6040      | pF       |
| C <sub>oss</sub>                   |  | apacitance                    |                     | f = 1  MHz   | 50 00       |       | 1445     | 1880      | pF       |
| C <sub>rss</sub>                   |  | Transfer Capacitance          |                     |  |             | -     | 100      | -         | pF       |
| C <sub>iss</sub>                   |  | pacitance                     |                     | V <sub>DS</sub> = 75 V, V <sub>GS</sub> =  | 0 V.        | -     | 4570     | 6040      | pF       |
| C <sub>oss</sub>                   |  | apacitance                    |                     | f = 1 MHz  | - ,         |       | 460      | 1880      | pF       |
| C <sub>rss</sub>                   |  | Transfer Capacitance          |                     |  |             | -     | 20       | -         | pF       |
| Q <sub>g(tot)</sub>                |  | te Charge at 10V              |                     | V <sub>DS</sub> = 120 V, I <sub>D</sub> =  | 75 A        | -     | 64.5     | 84        | nC       |
| Q <sub>gs</sub>                    |  | Source Gate Charge            |                     | $V_{GS} = 10 V$  | 1070,       | -     | 19.1     | -         | nC       |
| Q <sub>gs2</sub>                   |  | arge Threshold to Plate       | au                  | -  |             | -     | 8.7      | -         | nC       |
| Q <sub>gd</sub>                    |  | Drain "Miller" Charge         |                     | 6 4 MUL  | (Note       | ,     | 13.5     | -         | nC       |
| ESR                                | Equivale   | nt Series Resistance (G       | 5-5)                | f = 1 MHz  |             |       | 2.5      | -         | Ω        |
| Switching                          | Charact  | eristics                      |                     |  |             |       |          |           |          |
| t <sub>d(on)</sub>                 | 1  | Delay Time                    |                     |  |             | -     | 22       | 54        | ns       |
| t <sub>r</sub>                     |  | Rise Time                     |                     | $V_{DD} = 75 V, I_D = 75$  |             |       | 58       | 126       | ns       |
| t <sub>d(off)</sub>                | Turn-Off   | Delay Time                    |                     | V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω   |             | -     | 61       | 132       | ns       |
| t <sub>f</sub>                     | Turn-Off   | Fall Time                     |                     | _  | (Note       |       | 26       | 62        | ns       |
|                                    |  | . Characteristics             |                     |  |             | 1     | 1        |           |          |
|                                    | I  | e Characteristics             | Diad                | E  |             |       |          | 447       | •        |
| S                                  | Maximum Continuous Drain to Source Diode Forward Current<br>Maximum Pulsed Drain to Source Diode Forward Current |                               |                     |  | -           | -     | 117      | A         |          |
| SM                                 |  | Source Diode Forward          |                     |  | = ^         | -     | -        | 468       | A        |
| V <sub>SD</sub>                    |  | Recovery Time                 | vollage             | $V_{GS} = 0 V, I_{SD} = 75 A$ $V_{GS} = 0 V, I_{SD} = 75 A,$ $dI_{F}/dt = 100 A/\mu s$ |             | -     | 96       | 1.25      |          |
| t <sub>rr</sub><br>Q <sub>rr</sub> |  | Recovery Charge               |                     |  |             | _     | 268      |           | ns<br>nC |
|                                    | 1.010136   | Coovery Charge                |                     |  |             | -     | 200      |           |          |





## Typical Performance Characteristics (Continued)



1.10

1.05

10

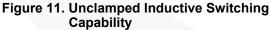
1

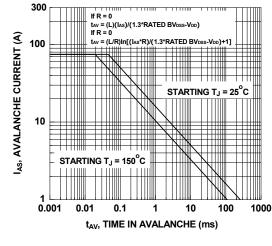
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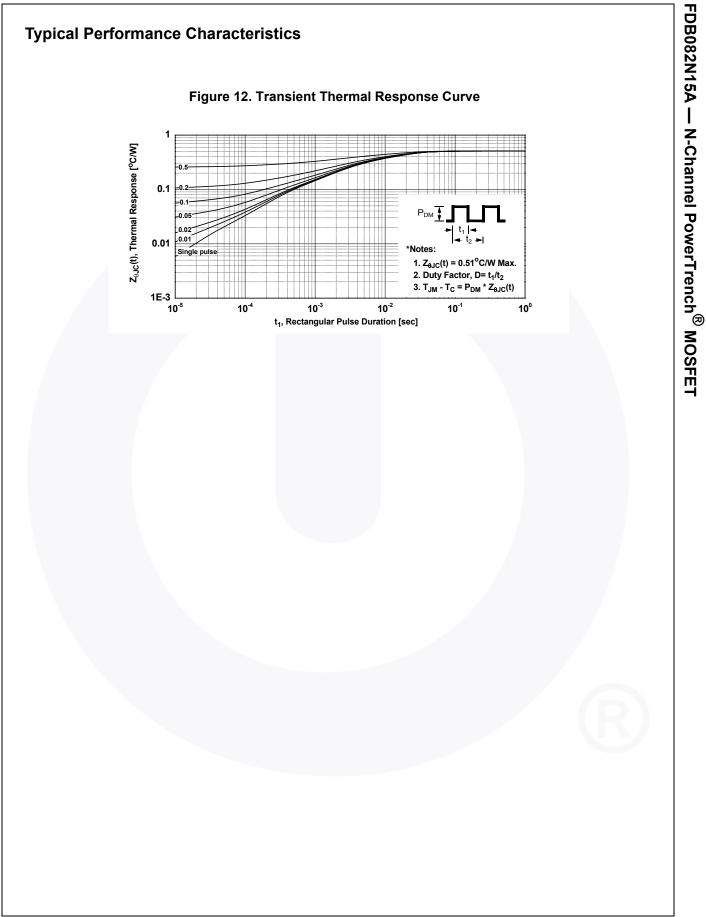
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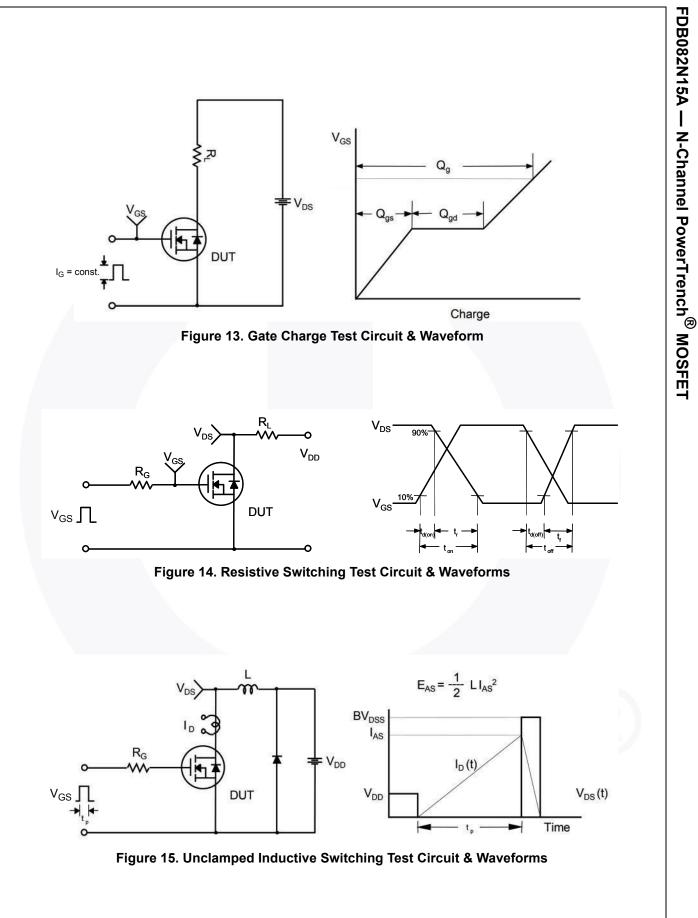
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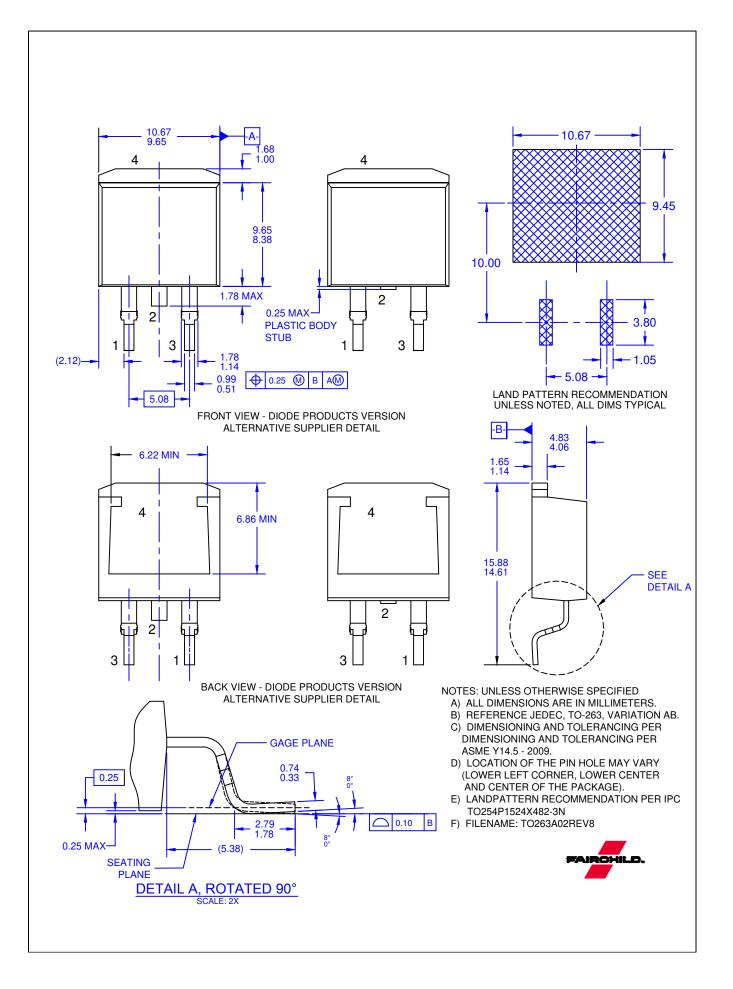
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DUT +  $V_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F V<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by R<sub>G</sub> • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>DD</sub> Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

FDB082N15A — N-Channel PowerTrench<sup>®</sup> MOSFET



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